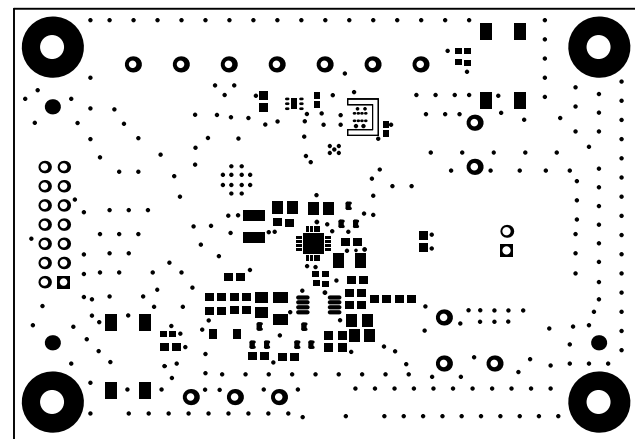
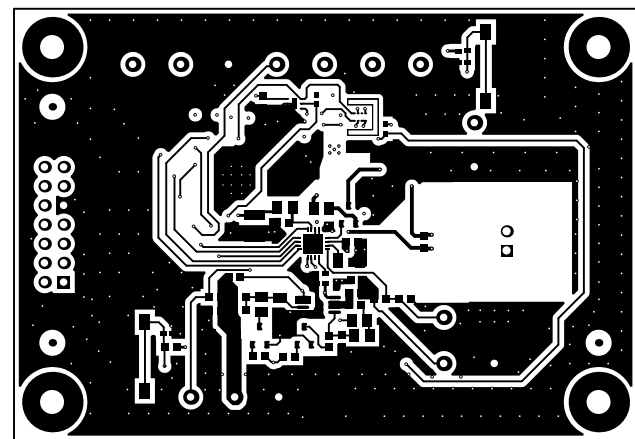


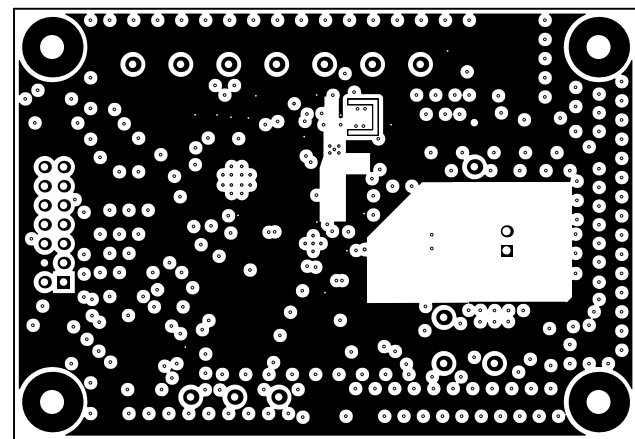
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4038	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: 00483		
PLOT NAME = Top Overlay	GENERATED : 9/9/2015	10:36:44 AM	TEXAS INSTRUMENTS



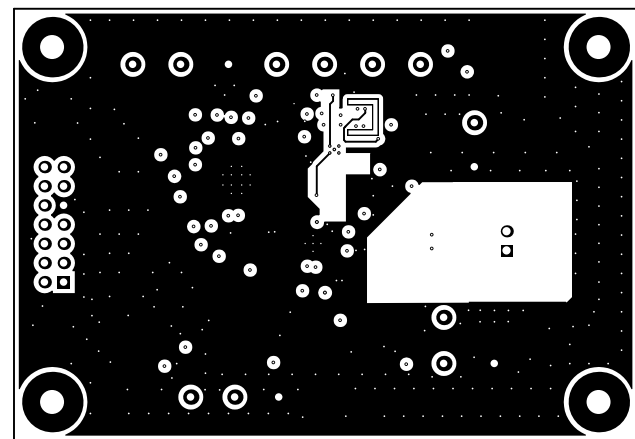
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4038	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: 00483		
PLOT NAME = Top Solder Mask	GENERATED : 9/9/2015 10:36:45 AM	TEXAS INSTRUMENTS	



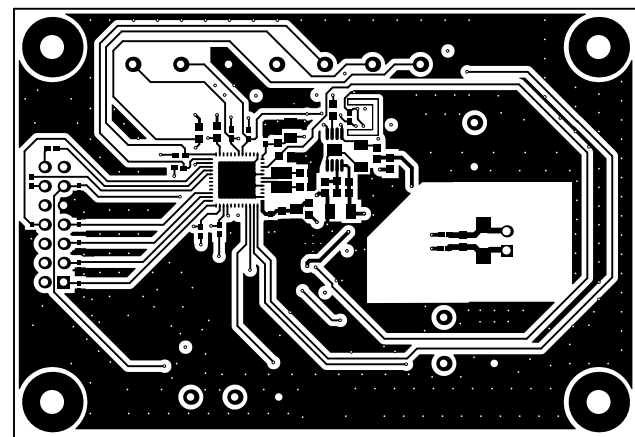
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4038	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: 00483		
PLOT NAME = Top Layer	GENERATED : 9/9/2015	10:36:47 AM	TEXAS INSTRUMENTS



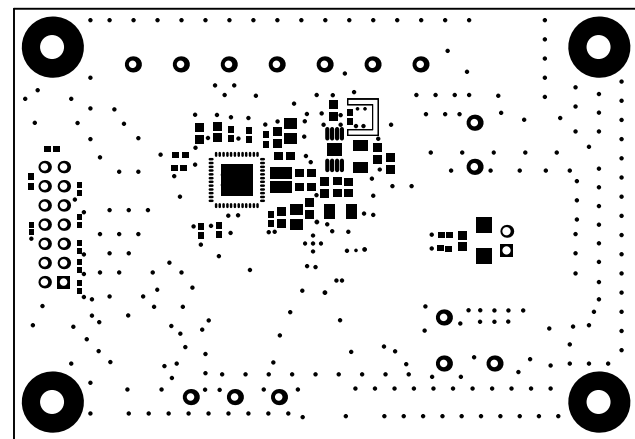
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4038	REV: E2	SUN REV: Not In VersionControl
LAYER NAME =	TID #: 00483		
PLOT NAME = Signal Layer 1	GENERATED : 9/9/2015	10:36:48 AM	TEXAS INSTRUMENTS



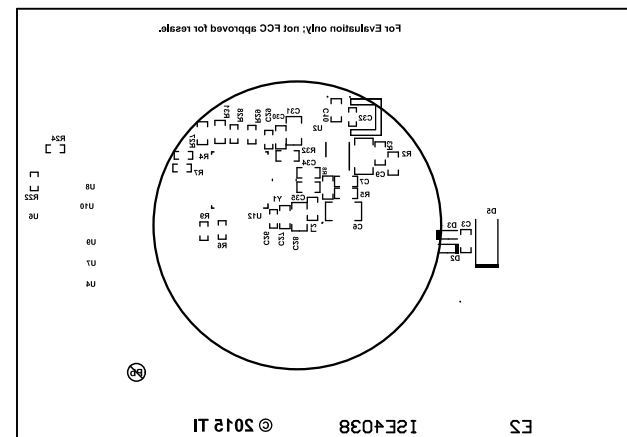
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4038	REV: E2	SUN REV: Not In VersionControl
LAYER NAME =	TID #: 00483		
PLOT NAME = Signal Layer 2	GENERATED : 9/9/2015	10:36:49 AM	TEXAS INSTRUMENTS



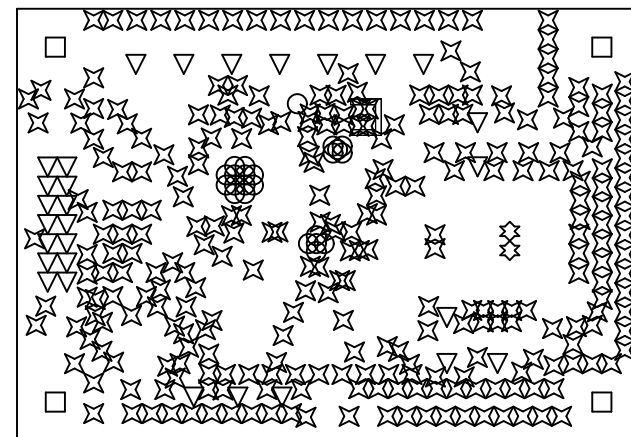
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4038	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: 00483		
PLOT NAME = Bottom Layer	GENERATED : 9/9/2015	10:36:50 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4038	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: 00483		
PLOT NAME = Bottom Solder Mask	GENERATED : 9/9/2015 10:36:51 AM	TEXAS INSTRUMENTS	

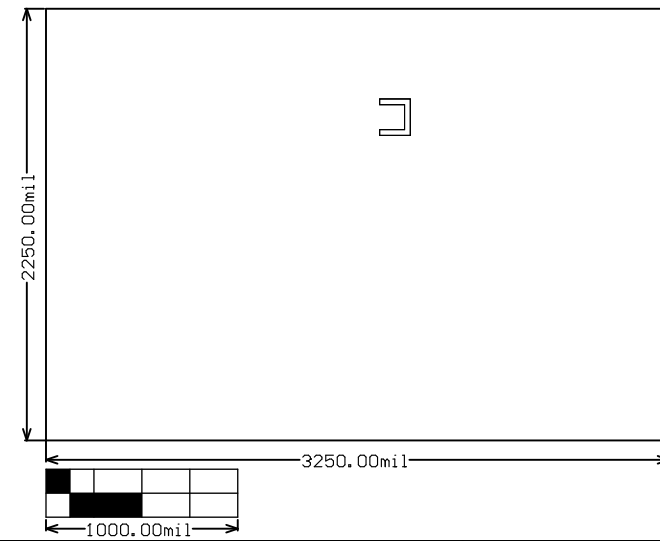


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4038	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: 00483		
PLOT NAME = Bottom Overlay	GENERATED : 9/9/2015	10:36:52 AM	TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	23	7.87mil (0.200mm)	PTH	Round
✱	292	10.00mil (0.254mm)	PTH	Round
▽	29	40.00mil (1.016mm)	PTH	Round
✱	2	43.31mil (1.100mm)	PTH	Round
□	4	125.98mil (3.200mm)	PTH	Round
	350 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4038	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: 00483		
PLOT NAME = Drill Drawing	GENERATED : 9/9/2015	10:36:53 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4038	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: 00483		
PLOT NAME = Board Dimensions	GENERATED : 9/9/2015	10:36:54 AM	TEXAS INSTRUMENTS

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